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EDWARDS & ANGELL, LLP			VINH, LAN	
P.O. BOX 55874 BOSTON, MA 02205			ART UNIT	PAPER NUMBER
			1765	
		DATE MAILED: 08/10/2006		

Please find below and/or attached an Office communication concerning this application or proceeding.

<u>. </u>						
	Application No.	Applicant(s)				
Office Action Summers	10/692,661	PAW ET AL.				
Office Action Summary	Examiner	Art Unit				
The MAIL INC DATE of this assumption to	Lan Vinh	1765				
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence address				
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).						
Status						
 1) Responsive to communication(s) filed on <u>06 Fe</u> 2a) This action is FINAL. 2b) This 3) Since this application is in condition for allowant closed in accordance with the practice under E 	action is non-final. ice except for formal matters, pro					
	n parte Gadyle, 1999 O.D. 11, 45					
Disposition of Claims		•				
4) Claim(s) 1-3 and 5-14 is/are pending in the app 4a) Of the above claim(s) is/are withdraw 5) Claim(s) is/are allowed. 6) Claim(s) 1-3 and 5-14 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/or	n from consideration.					
Application Papers						
9) The specification is objected to by the Examiner 10) The drawing(s) filed on is/are: a) acce Applicant may not request that any objection to the d Replacement drawing sheet(s) including the correction 11) The oath or declaration is objected to by the Examiner	epted or b) objected to by the E frawing(s) be held in abeyance. See on is required if the drawing(s) is obj	e 37 CFR 1.85(a). ected to. See 37 CFR 1.121(d).				
Priority under 35 U.S.C. § 119						
12) Acknowledgment is made of a claim for foreign part a) All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the priority application from the International Bureau * See the attached detailed Office action for a list of	have been received. have been received in Application ty documents have been received (PCT Rule 17.2(a)).	on No d in this National Stage				
Attachment(s)						
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal Pa 6) Other:	(PTO-413) te atent Application (PTO-152)				

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DETAILED ACTION

Response to Amendment/Arguments

1. The indicated allowability of claim 10 is withdrawn in view of the newly discovered reference(s) to Merchant et al (US 6,458,289). Non-final rejections based on the newly cited reference follow.

Claim Rejections - 35 USC § 103

- 2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 3. Claims 1, 2-3, 5, 12 are rejected under 35 U.S.C. 103(a) as being unpatentable over llardi et al (US 5,466,389) in view of Sun (US 6,641,630) and further in view of Merchant et al (US 6,458,289)

llardi discloses a method for cleaning microelectronic substrate. The method comprises the steps of:

supplying a substrate fabricated substantially of silicon (col 5, lines 48-50)
exposing the substrate to an alkaline cleaner solution (col 3, lines 56-60), which
reads on exposing the substrate to an etching bath containing a caustic etching solution
the cleaner solution contains additives such as chlorite salt, an iodate salt (col 4, lines
21-28)

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Unlike the instant claimed inventions as per claims 1-3, llardi fails to disclose using additive such as a mixture of potassium iodate and sodium iodate in the caustic cleaner solution

Sun discloses an alkaline CMP solution contains additive such as a mixture of potassium iodate and sodium iodate (col 6, lines 8-10, col 7, lines 35-38)

Since llardi discloses that the cleaner solution contains additives such as iodate salt, chlorite salt, one skilled in the art at the time the invention was made would have found it obvious to modify llardi method by adding a mixture of potassium iodate and sodium iodate in the caustic cleaner solution in view of Sun teaching because Sun discloses that iodates are suitable oxidizing agent for a polishing/cleaning composition (col 3, lines 5-16)

llardi and Sun fail to disclose the steps of removing a portion of the solution from the etching bath, exposing the portion of removed solution to the additive and returning the exposed portion of removed solution to the etching bath

Mechant discloses a method of polishing comprises the steps of removing a used aqueous polishing slurry from the polishing solution/portion of the solution from the etching bath, exposed the used slurry/portion of the removed solution to additives and recirculating/returning the exposed slurry/solution to the polishing solution (col 4, lines 45-67; col 5, lines 1-5; fig. 4)

One skilled in the art at the time the invention was made would have found it obvious to modify llardi and Sun method by adding the step of removing a portion of the solution from Illardi etching bath, exposing the portion of removed solution to the additive as

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taught by Sun and returning the exposed portion of removed solution to the etching bath in view of Merchant teaching in order to produce a freshly-mixed and conditioned etching solution, thus preventing the contamination of wafers during the alkaline cleaning step

Regarding claim 5, llardi discloses that the alkaline cleaner comprises 0.1-10 % of addictive (col 13, lines 10-13), which reads on wherein the additive has an additive concentration of at least about 0.01% by weight.

Regarding claim 12, llardi discloses that any suitable alkaline may be used in the cleaner composition (col 2, lines 65-66)

4. Claims 6-8, 13-14 are rejected under 35 U.S.C. 103(a) as being unpatentable over llardi et al (US 5,466,389) in view of Sun (US 6,641,630) and Merchant et al (US 6,458,289) and further in view of Maeno et al (US 5,714,407)

Ilardi as modified by Sun and Merchant has been described above. Unlike the instant claimed inventions as per claims 6-8, Ilardi, Sun and Merchant fail to disclose forming the additive by chemical reaction between iodic acid and hydroxide/I2 with chlorate in the etching bath

Maeno also discloses forming the additive by chemical reaction of the iodic acid in the etching solution (col 5, lines 9-12)

One skilled in the art at the time the invention was made would have found it obvious to modify llardi, Sun and Merchant method by using iodic acid in the cleaner solution because Maeno discloses that the etching agent preferably contains iodine ions

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because the addition of iodine ions changes iodine generated by the etching into I₃-which dissolves the agent, thereby preventing the precipitation of halogen or the like, thus it is possible to prevent etching defects (col 5, lines 15-19)

Unlike the instant claimed inventions as per claims 13-14, Ilardi, Sun and Merchant fail to disclose the step of replenishing the addictive by adding more iodate salt as the iodate salt is depleted

Maeno also discloses the step of adding more halooxoacid salt/iodate salt to the etching solution (col 6, lines 33-50)

Hence, one skilled in the art at the time the invention was made would have found it obvious to modify llardi and Sun cleaner solution by adding/replenish more iodate salt as the iodate salt/additive is depleted in view of Maeno teaching because Maeno discloses that it is preferable that the concentration of halooxoacid salt is at least 0.04 mol/l to produce uniform etching (col 6, lines 54-56)

5. Claim 9 is rejected under 35 U.S.C. 103(a) as being unpatentable over llardi et al (US 5,466,389) in view of Sun (US 6,641,630) and Merchant et al (US 6,458,289) and further in view of Morita et al (US 6,431,186)

llardi as modified by Sun and Merchant has been described above. Unlike the instant claimed inventions as per claims 9, 10, llardi and Sun and Merchant fail to disclose using additives such as sodium chlorite/chlorite salt

Morita discloses a method for cleaning electronic component using a cleaning solution contains additive such as sodium chlorite (col 3, lines 15-17)

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Since llardi cleaner solution is an alkaline solution, one skilled in the art at the time the invention was made would have found it obvious to modify llardi, Sun and Merchant cleaner solution by using additive such as sodium chlorite as per Morita because according to Morita, fluids contains oxidizing substance such as sodium chlorite supplemented with an alkaline solution can be used (col 3, lines 12-33)

6. Claim 10 is rejected under 35 U.S.C. 103(a) as being unpatentable over llardi et al (US 5,466,389) in view of Merchant et al (US 6,458,289)

llardi discloses a method for cleaning microelectronic substrate. The method comprises the steps of:

supplying a substrate fabricated substantially of silicon (col 5, lines 48-50)
exposing the substrate to an alkaline cleaner solution (col 3, lines 56-60), which
reads on exposing the substrate to an etching bath containing a caustic etching solution
the cleaner solution contains additives such as chlorite salt, an iodate salt (col 4, lines
21-28)

Unlike the instant claimed invention as per claim 10, Ilardi fails to disclose the steps of removing a portion of the solution from the etching bath, exposing the portion of removed solution to the additive and returning the exposed portion of removed solution to the etching bath

Mechant discloses a method of polishing comprises the steps of removing a used aqueous polishing slurry from the polishing solution/portion of the solution from the etching bath, exposed the used slurry/portion of the removed solution to additives and

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recirculating/returning the exposed slurry/solution to the polishing solution (col 4, lines 45-67; col 5, lines 1-5; fig. 4)

One skilled in the art at the time the invention was made would have found it obvious to modify llardi method by adding the step of removing a portion of the solution from Illardi etching bath, exposing the portion of removed solution to the additive and returning the exposed portion of removed solution to the etching bath in view of Merchant teaching in order to produce a freshly-mixed and conditioned etching solution, thus preventing the contamination of wafers during the alkaline cleaning step

7. Claim 11 is rejected under 35 U.S.C. 103(a) as being unpatentable over llardi et al (US 5,466,389) in view of Sun (US 6,641,630) and Merchant et al (US 6,458,289) and further in view of Lack et al (US 2001/0044264 A1)

llardi as modified by Sun and Merchant has been described above. Unlike the instant claimed invention as per claim 11, llardi, Sun and Merchant fail to disclose using lithium iodate as an addictive

Lack discloses a method for polish semiconductor substrate using a polishing composition/etching composition includes lithium iodate as an oxidizing agent/addictive (col 2, paragraph 0039)

Since llardi discloses that the cleaner solution contains additive such as an oxidizing agent, one skilled in the art at the time the invention was made would have found it obvious to modify llardi, Sun and Merchant cleaner solution by adding additives such as

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lithium iodate as per Lack because Lack discloses that an oxidizing agent that can be added to a polishing solution includes lithium iodate (col 2, paragraph 0039)

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Conclusion

8. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Lan Vinh whose telephone number is 571 272 1471. The examiner can normally be reached on M-F 8:30-5:30 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nadine Norton can be reached on 571 272 1465. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

LV

August 5, 2006